Product summary

MAYA-W3 series

Host-based Wi-Fi 6/6E and Bluetooth® 5.4 modules for the IoT

Standard

Small, low-power, secure modules for IoT applications

- Single-band, dual-band, and tri-band Wi-Fi 6/6E
- Dual-mode Bluetooth Classic and Bluetooth Low Energy 5.4
- · Bluetooth LE Audio
- · Efficient coexistence management between internal and external radios
- Variants with PCB-antenna, U.FL connector(s), and antenna pins
- · Secure boot and secure OTP











Product description

The MAYA-W3 series host-based modules are designed, built, and tested to meet the high reliability and quality requirements of a wide range of industrial applications, such as smart manufacturing, tracking and telematics, building automation, professional appliances, healthcare, and EV charging infrastructures.

MAYA-W3 modules provide SISO Wi-Fi 6/6E operation with 20 MHz channel width, improved network availability in dense Wi-Fi environments, and MU-MIMO. The modules can work as access point, station, in P2P connections, or combinations of these. MAYA-W3 supports Bluetooth Low Energy 5.4, including the use of isochronous channels for LE Audio.

At 10.4 x 14.3 mm, MAYA-W3 are among the most compact Wi-Fi 6/6E SMD modules available in the market.

All u-blox modules undergo extensive qualification tests to ensure reliability over their life-time, and each module is fully tested before leaving the assembly line.

The MAYA-W3 series is based on the CYW5551/2/3 chips from Infineon.

Key features

- · Variants with antenna pins, U.FL connectors, and embedded PCB antenna
- Wi-Fi 6/6E, tri-band, dual-band, and single-band; single stream, supporting MU-MIMO
- 20 MHz Wi-Fi channels
- Wi-Fi 802.11a/b/g/n/ac/ax/ d/e/h/i/r/w
- Bluetooth 5.4 supporting LE Audio
- · Wi-Fi security: WPA3, WPA2, WAPI, AES
- High-power Bluetooth: up to +20 dBm
- · Secure boot
- Industrial temperature range -40 °C to +85 °C

	MAYA-W33 MAYA-W33 MAYA-W33	MAYA-W36 MAYA-W36 MAYA-W36	MAYA-W38 MAYA-W38 MAYA-W38
Grade			
Automotive Professional	•		
Standard			
Radio			
Chip inside	CYW55511	CYW55512	CYW55513
Bluetooth qualification	v5.4	v5.4	v5.4
Bluetooth profiles	HCI	HCI	HCI
Bluetooth Classic	•	•	•
Bluetooth Low Energy	•	•	•
Bluetooth output power conducted [dBm]	up to 20	up to 20	up to 20
Wi-Fi IEEE 802.11 stds	Wi-Fi 6	6 (802.11a/b/g/r	ı/ac/ax)
Wi-Fi freq. band [GHz]	2.4	2.4 and 5	2.4, 5, and 6
Wi-Fi output power [dBm]	18	18	18
Antenna type	U.FL pins pcb	U.FL pins pcb	U.FL pins pcb
Number of antennas	2 2 1	2 2 1	2 2 1
OS support			
Android/Linux drivers	•	•	•
RTOS (via NXP MCU)	•	•	•
Interfaces			
High-speed UART (Bluetooth)	1	1	1
PCM, I2S (Bluetooth audio)	1	1	1
SDIO (Wi-Fi) [version]	3.0	3.0	3.0
Features			
Micro access points [max]	16	16	16
Wi-Fi direct	•	•	•
WPA3	•	•	•
RF calibration in OTP	•	•	•
Programmed MAC addr.	•	•	•
Secure boot	•	•	•
pins = 2 antenna pins	U.F	L = 2 U.FL ante	nna connectors

30 33 33 33 33 34 36 36 36 36 38 38

pcb = internal PCB antenna and pin



UBX-23011166 - R01 Objective Specification

MAYA-W3 series



Features	
Wi-Fi standards	Wi-Fi 6/E IEEE 802.11a/b/g/n/ac/ax IEEE 802.11d/e/h/i/r/w
Wi-Fi channels	2.4 GHz: 1-14 5 GHz: 36-196 6 GHz: 1-233
Bluetooth	v5.4 Classic and LE long range, power management, LE Audio
Antennas	MAYA-W330, MAYA-W360 and MAYA-W380: 2 U.FL connectors MAYA-W331, MAYA-W361 and MAYA-W381: 2 antenna pins MAYA-W336, MAYA-W366 and MAYA-W386: 1 antenna via pin or embedded in PCB
Wi-Fi output Tx-power	18 dBm (Wi-Fi 6, 5 GHz, 20 MHz channel)
RX sensitivity	Wi-Fi 6 2.4 GHz: -95 dBm (indicative) Wi-Fi 6 5 GHz: -94 dBm (indicative) Bluetooth Classic: -94 dBm (indicative) Bluetooth LE: -100.5 dBm (1 Mbit/s, indicative)
Security	128-bit AES hardware encryption Secure boot

Software	features
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Available in on-board OTP memory
Available in on-board OTP memory
WPA2 (CCMP, AES) WPA3 WAPI
Station, access point, Wi-Fi direct, or any combination of these
Free of charge drivers for Linux and Android
Internal TDM mechanism Central hardware packet traffic arbitration for external radio WCI-2 interface for external radio coexistence

Interfaces

Wi-Fi	SDIO 3.0 (4-bit, up to 100 MHz clock)	
Bluetooth	4-wire high-speed UART PCM and I2S for Bluetooth audio	
Coexistence	WCI-2 (2-wire) Zigbee (3-wire) UWB (3-wire) 4-wire LTE	
Other	GPIOs	

Package

Dimensions	10.4 × 14.3 × 1.9 mm
Mounting	Soldering, 90 pins (LGA)

Environmental data, quality, and reliability

Operating temperature -40 °C to +85 °C	
Moisture sensitivity level 4	
RoHS and REACH compliance	

Electrical data

RF power supply	3.13 – 3.46 VDC
I/O power supply	3.3 VDC or 1.8 VDC

Certifications and approvals

Type approvals	Europe (RED); US (FCC); Canada (ISED); Japan (Giteki) Other certifications to be considered upon request
Bluetooth qualification	v5.4 (Bluetooth Classic and Bluetooth Low Energy)

Support products

E\/k_N/\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\	Evaluation kit for all MAVA-M3 modules

Product variants

Single-band Wi-Fi 6 and Bluetooth 5.4 module with two separate U.FL connectors
Single-band Wi-Fi 6 and Bluetooth 5.4 module with two separate antenna pins
Single-band Wi-Fi 6 and Bluetooth 5.4 module with embedded PCB antenna
Dual-band Wi-Fi 6 and Bluetooth 5.4 module with two separate U.FL connectors
Dual-band Wi-Fi 6 and Bluetooth 5.4 module with two separate antenna pins
Dual-band Wi-Fi 6 and Bluetooth 5.4 module with embedded PCB antenna
Tri-band Wi-Fi 6E and Bluetooth 5.4 module with two separate U.FL connectors
Tri-band Wi-Fi 6E and Bluetooth 5.4 module with two separate antenna pins
Tri-band Wi-Fi 6E and Bluetooth 5.4 module with embedded PCB antenna

Further information

For contact information, see ${\bf www.u-blox.com/contact-u-blox}.$

For more product details and ordering information, see the product data sheet. $% \left(1\right) =\left(1\right) \left(1\right) \left($

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